

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KOJI NONOBE	10/11/2017
TAKASHI MITSUYA	10/11/2017
RYUYA KOIZUMI	10/11/2017
KUNIO OISHI	10/11/2017
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15868753
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DATE SIGNED:	01/22/2018
Total Attachments: 3	
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ASSIGNMENT

WHEREAS, I, **Koji NONOBE**, a citizen of **Japan**, residing at **c/o Hosei University of 2-17-1, Fujimi, Chiyoda-ku, Tokyo 102-8160 Japan**, and, **Takashi MITSUYA, Ryuya KOIZUMI** and **Kunio OISHI**, citizens of **Japan**, residing at **c/o Ebara Corporation of 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan**, respectively, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number 101728.000090 ("the invention"), which is entitled

**SCHEDULER, SUBSTRATE PROCESSING APPARATUS, AND SUBSTRATE
CONVEYANCE METHOD**

("the subject application"), and which claims priority to patent application number **005729/2017** filed **January 17, 2017** ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, **EBARA CORPORATION**, ASSIGNEE, having a place of business at **11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan**, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

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AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 11th day of October, year of 2017.

Koji Nonobe

Signature: Koji NONOBE

Takashi Mitsuya.

Signature: Takashi MITSUYA

Ryuya Koizumi

Signature: Ryuya KOIZUMI

Kunio Oishi

Signature: Kunio OISHI

DOCKET NO.: 101728.000090

STATEMENT OF WITNESS

SIGNED at Tokyo, Japan

(City) (Country)

This 11th day of October, 2017.

I, Takashi KISHI whose full

residence address is c/o Ebara Corporation of 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo 144-8510 Japan was personally present and did see Koji NONOBE, Takashi MITSUYA, Ryuya KOIZUMI and Kunio OISHI execute the above assignment on the 11th day of October, 2017, and such assignor is personally known to me to be the person described in such document.

Takashi Kishi

Signature of Witness

The foregoing assignment covers patent application number 15/868,753, filed on January 11, 2018.

/Michael J. Swope/

Name of Attorney: Michael J. Swope

Registration No.: 38,041

Date of Insertion: January 22, 2018